

Features

- Trench MV MOSFET Technology
- Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant (Note 2) ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

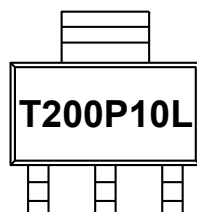
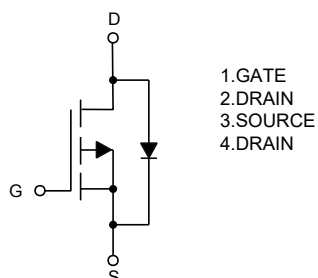
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 76°C/W Junction to Ambient (Note 3)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	-100	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous Drain Current	I_D	$T_A=25^\circ\text{C}$	A
		$T_A=100^\circ\text{C}$	
Pulsed Drain Current (Note 4)	I_{DM}	-8	A
Total Power Dissipation (Note 5)	P_D	1.64	W

Note:

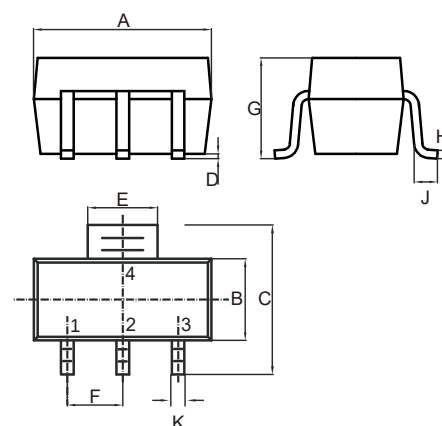
1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. High Temperature Solder Exemption Applied, see EU Directive Annex 7(a)-I.
3. The value of $R_{\theta JA}$ is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.
4. Repetitive rating; pulse width limited by max. junction temperature.
5. P_D is based on max. junction temperature, using junction-ambient thermal resistance.

Internal Structure and Marking Code



P-CHANNEL MOSFET

SOT-223



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.248	0.264	6.30	6.70	
B	0.130	0.146	3.30	3.70	
C	0.264	0.287	6.70	7.30	
D	0.001	0.004	0.02	0.10	
E	0.114	0.122	2.90	3.10	
F	0.091		2.30		TYP.
G	---	0.071	---	1.80	
H	0.009	0.014	0.23	0.35	
J	0.030	---	0.75	---	
K	0.026	0.033	0.66	0.84	

Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =-250μA	-100			V
Gate-Source Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-100V, V _{GS} =0V			-1	μA
Gate-Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-1	-1.5	-2	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =-10V, I _D =-2A		158	200	mΩ
		V _{GS} =-4.5V, I _D =-1A		168	250	
Gate Resistance	R _g	f=1 MHz, Open drain		18		Ω
Diode Characteristics						
Continuous Body Diode Current	I _S				-2	A
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =-2A			-1.2	V
Reverse Recovery Time	t _{rr}	I _F =-2A, dI/dt=100A/μs		24		ns
Reverse Recovery Charge	Q _{rr}			32		nC
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} =-50V, V _{GS} =0V, f=1MHz		1369		pF
Output Capacitance	C _{oss}			34		
Reverse Transfer Capacitance	C _{rss}			29		
Total Gate Charge	Q _g	V _{DS} =-50V, V _{GS} =-10V, I _D =-2A		25.5		nC
Gate-Source Charge	Q _{gs}			2.6		
Gate-Drain Charge	Q _{gd}			3.1		
Turn-On Delay Time	t _{d(on)}	V _{DD} =-10V, V _{GS} =-4.5V, R _G =3Ω, I _D =-2A		11		ns
Turn-On Rise Time	t _r			22		
Turn-Off Delay Time	t _{d(off)}			104		
Turn-Off Fall Time	t _f			54		

Curve Characteristics

Fig. 1 - Typical Output Characteristics

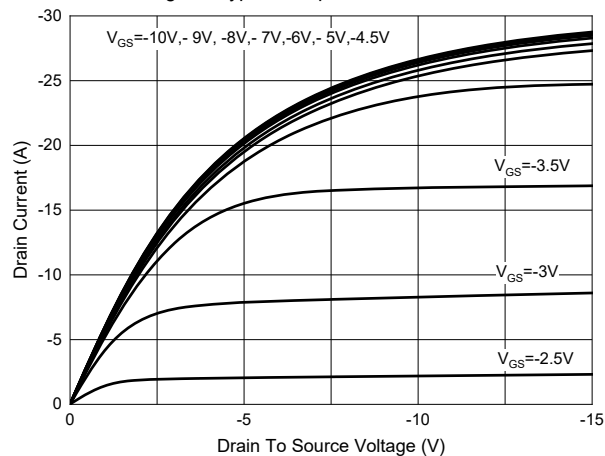


Fig. 2 - Transfer Characteristics

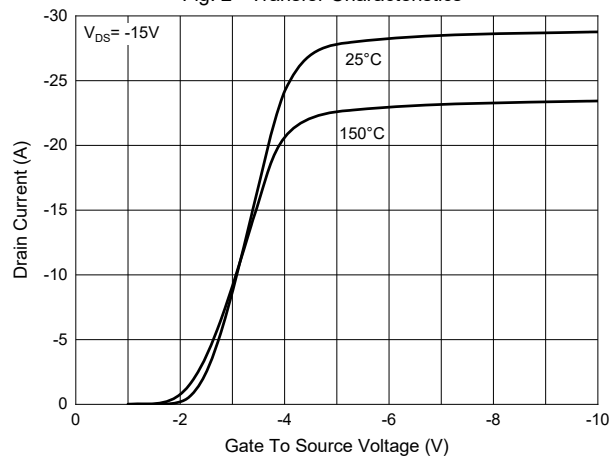


Fig.3- $R_{DS(ON)}$ - V_{GS}

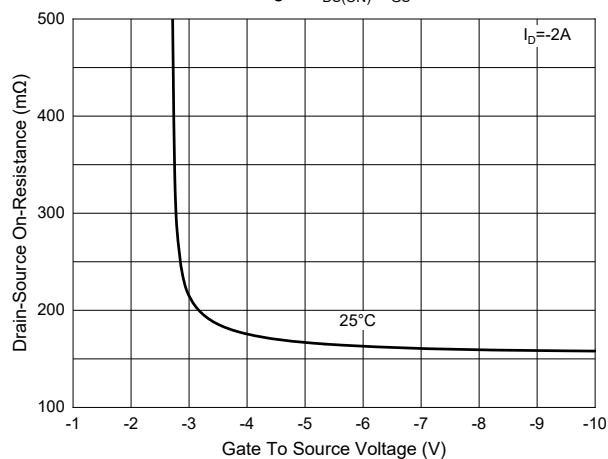


Fig.4- $R_{DS(ON)}$ - I_D

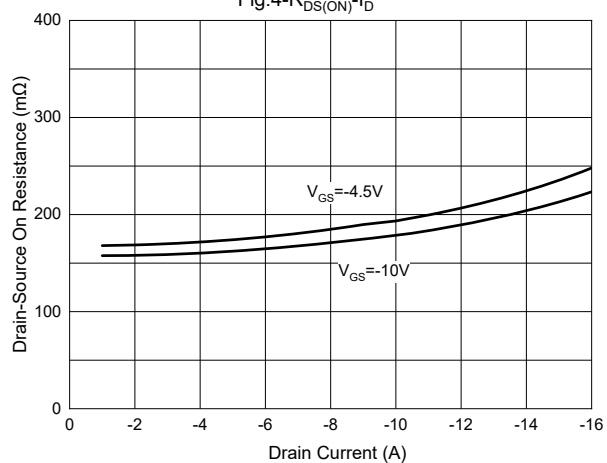


Fig. 5 - Capacitance Characteristics

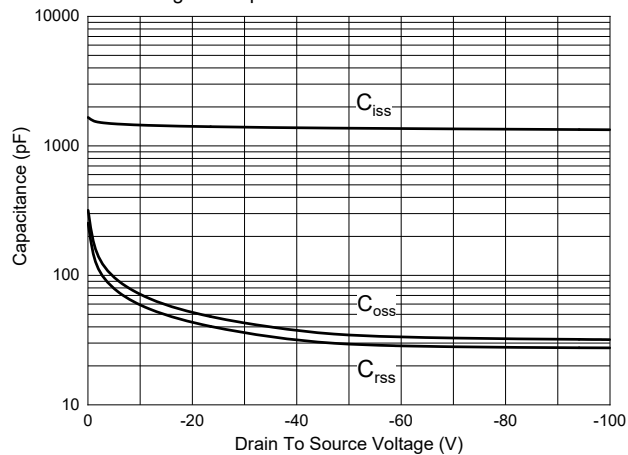
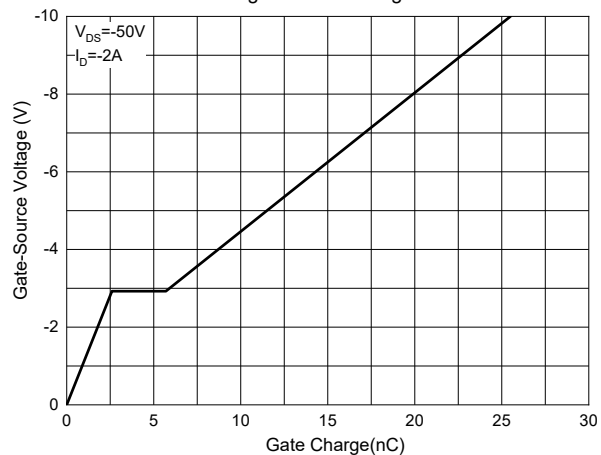


Fig. 6 - Gate Charge



Curve Characteristics

Fig. 7 - Normalized Threshold Voltage

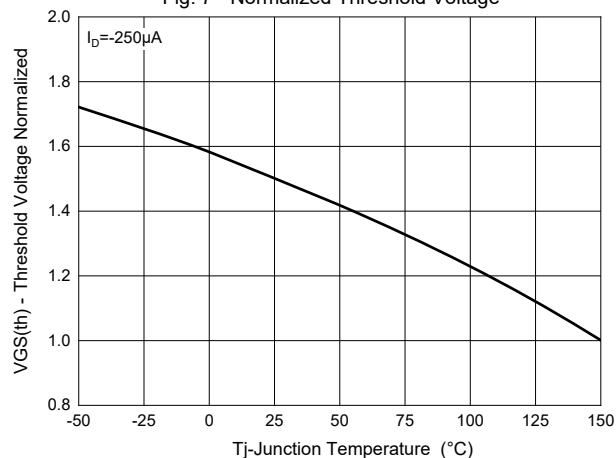


Fig. 8 - Normalized On Resistance Characteristics

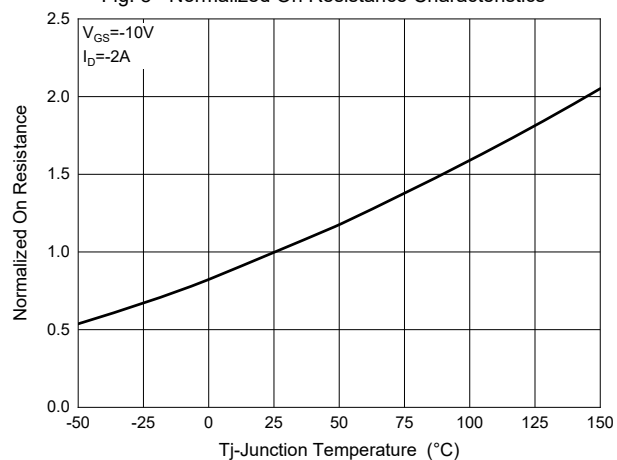


Fig.9- I_S - V_{SD}

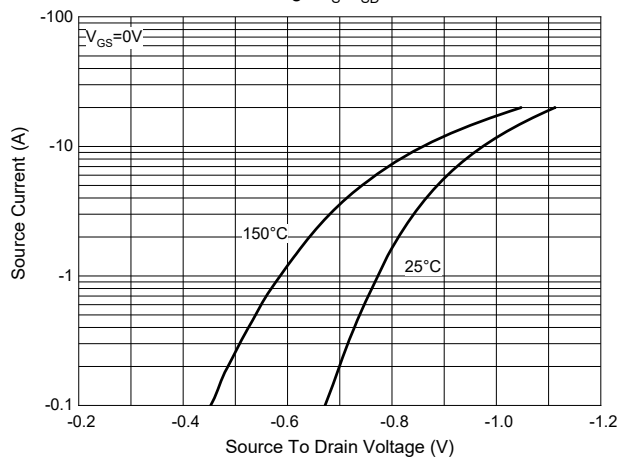


Fig. 10 - Drain Current

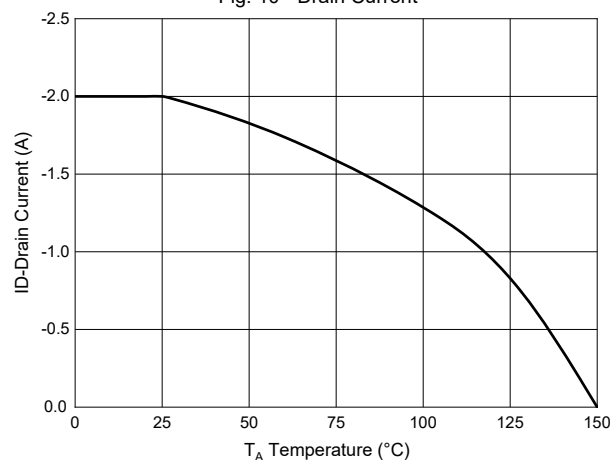
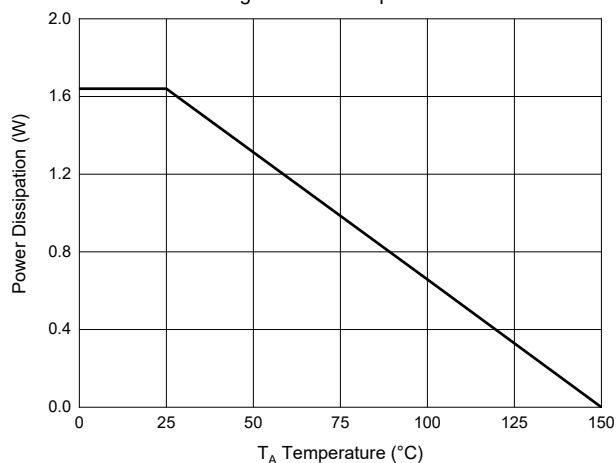


Fig. 11 - PD Dissipation



Curve Characteristics

Fig. 12 - Safe Operation Area

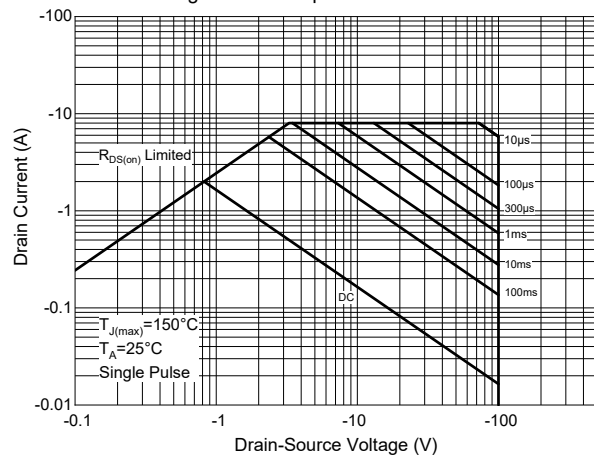
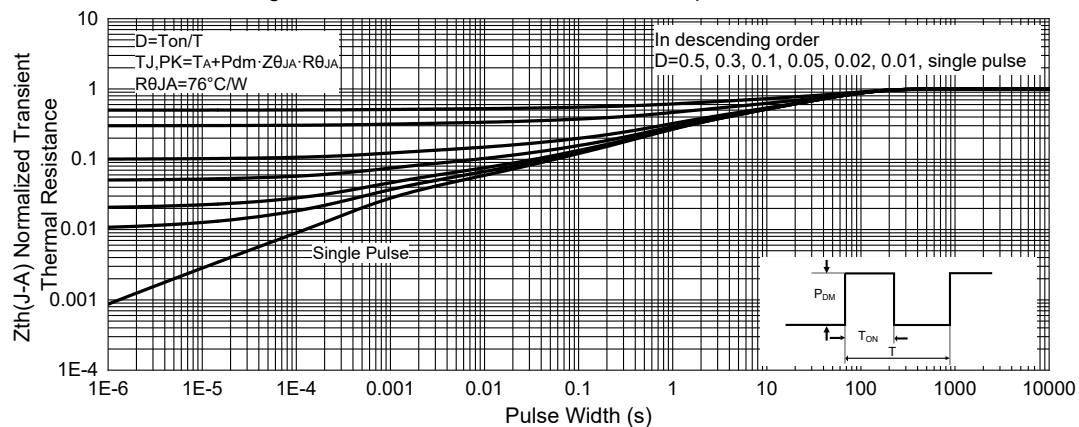


Fig. 13 - Normalized Transient Thermal Impedance



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 2.5Kpcs/Reel

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